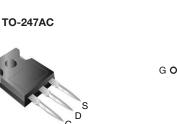
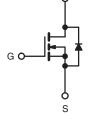


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Power MOSFET

| PRODUCT SUMMARY | | | | | |
|----------------------------|-----------------|------|--|--|--|
| V _{DS} (V) | 500 | | | | |
| R _{DS(on)} (Ω) | $V_{GS} = 10 V$ | 0.28 | | | |
| Q _g (Max.) (nC) | 130 | | | | |
| Q _{gs} (nC) | 33 | | | | |
| Q _{gd} (nC) | 59 | | | | |
| Configuration | Single | | | | |





N-Channel MOSFET

FEATURES

· SuperFast Body Diode Eliminates the Need For External Diodes in ZVS Applications



RoHS

COMPLIANT

- Low Gate Charge Results in Simple Drive Requirement
- Enhanced dV/dt Capabilities Offer Improved Ruggedness
- Higher Gate Voltage Threshold Offers Improved Noise Immunity
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Zero Voltage Switching SMPS
- Telecom and Server Power Supplies
- Uninterruptible Power Supply
- Motor Control applications

| ORDERING INFORMATION | |
|----------------------|----------------|
| Package | TO-247AC |
| Lead (Pb)-free | IRFP17N50LPbF |
| | SiHFP17N50L-E3 |
| SnPb | IRFP17N50L |
| | SiHEP17N501 |

| ABSOLUTE MAXIMUM RATINGS (T _C | = 25 °C, unl | ess otherwis | se noted) | | | |
|--|-------------------------|-----------------------------------|------------------|------------------|----------|--|
| PARAMETER | | | SYMBOL | LIMIT | UNIT | |
| Drain-Source Voltage | | | V _{DS} | 500 | v | |
| Gate-Source Voltage | | | V _{GS} | ± 30 | v | |
| Continuous Drain Current | V _{GS} at 10 V | T _C = 25 °C | - I _D | 16 | | |
| | | T _C = 100 °C | | 11 | А | |
| Pulsed Drain Current ^a | | | I _{DM} | 64 | | |
| Linear Derating Factor | | | | 1.8 | W/°C | |
| Single Pulse Avalanche Energy ^b | | | E _{AS} | 390 | mJ | |
| Repetitive Avalanche Current ^a | | | I _{AR} | 16 | А | |
| Repetitive Avalanche Energy ^a | | | E _{AR} | 22 | mJ | |
| Maximum Power Dissipation | T _C = 25 °C | | P _D | 220 | W | |
| Peak Diode Recovery dV/dt ^c | | | dV/dt | 13 | V/ns | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to + 150 | | | |
| Soldering Recommendations (Peak Temperature) | for 10 s | | | 300 ^d | - °C | |
| Mounting Torque | 6-32 or M3 screw | | | 10 | lbf · in | |
| | | | | 1.1 | N · m | |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Starting T_J = 25 °C, L = 3.0 mH, R_g = 25 Ω , I_{AS} = 16 A (see fig. 12). c. I_{SD} ≤ 16 A, dI/dt ≤ 347 A/µs, V_{DD} ≤ V_{DS}, T_J ≤ 150 °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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| PARAMETER | SYMBOL | TYP | | MAX. | | | UNIT | | |
|---|-------------------------|--|--|----------------------------|------|-------|-------|----------|--|
| | | | | | UNIT | | | | |
| Maximum Junction-to-Ambient | R _{thJA} | - 62 | | | | 00.00 | | | |
| Case-to-Sink, Flat, Greased Surface Maximum Junction-to-Case (Drain) | R _{thCS} | 0.50 - | | | | °C/W | | | |
| Maximum Junction-to-Case (Drain) | R _{thJC} | - 0.56 | | | | | | | |
| SPECIFICATIONS (T _J = 25 °C, u | nless otherw | ise noted) | | | | | | | |
| PARAMETER | SYMBOL | TEST CONDITIONS | | | MIN. | TYP. | MAX. | UNI | |
| Static | | | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} : | = 0 V, I _D = 25 | i0 μA | 500 | - | - | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | | e to 25 °C, I _D | | - | 0.60 | - | V/° | |
| Gate-Source Threshold Voltage | V _{GS(th)} | | = V _{GS} , I _D = 25 | | 3.0 | - | 5.0 | V | |
| Gate-Source Leakage | I _{GSS} | | $V_{GS} = \pm 30 V$ | | - | _ | ± 100 | nA | |
| | 'G88 | $V_{GS} = \pm 30 V$ $V_{DS} = 500 V, V_{GS} = 0 V$ | | | - | - | 50 | μA | |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{DS} = 500 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ $V_{DS} = 400 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$ | | | - | _ | 2.0 | m/ | |
| Drain-Source On-State Resistance | P | | | | - | 0.28 | 0.32 | Ω | |
| Forward Transconductance | R _{DS(on)} | $\begin{array}{c c c c c c c c c c c c c c c c c c c $ | | 11 | - | - | S | | |
| | 9 _{fs} | VDS - | = 50 v, i <u>D</u> = 9 | .5 A- | 11 | _ | | 3 | |
| Dynamic | <u> </u> | [| | | - | 0760 | - | r | |
| Input Capacitance | C _{iss} | V _{GS} = 0 V, V _{DS} = 25 V, f = 1.0 MHz, see fig. 5 | | | 2760 | - | | | |
| Output Capacitance | C _{oss} | | | - | 325 | - | | | |
| Reverse Transfer Capacitance | C _{rss} | 1 = 1 | | | | 37 | - | pF | |
| Output Capacitance | C _{oss} | | | = 1.0 V , f = 1.0 MHz | | 3690 | - | | |
| | | | $V_{DS} = 400 \text{ V}$, f = 1.0 MHz | - | 84 | - | | | |
| Effective Output Capacitance | C _{oss} eff. | $V_{GS} = 0 V$ | | - | 159 | - | | | |
| Effective Output Capacitance (Energy Related) | C_{oss} eff. (ER) | | V _{DS} = 0 V to 400 V | | - | 120 | - | | |
| Internal Gate Resistance | R _g | f = 1 | MHz, open o | drain | - | 1.4 | - | Ω | |
| Total Gate Charge | Qg | | I _D = 16 A, V _{DS} = 40 see fig. 7 and 15 | V 400 V | - | - | 130 | nC | |
| Gate-Source Charge | Q _{gs} | $V_{GS} = 10 V$ | | 50 | - | - | 33 | | |
| Gate-Drain Charge | Q _{gd} | | see lig. 7 and 15 | | - | - | 59 | 1 | |
| Turn-On Delay Time | t _{d(on)} | | | | - | 21 | - | | |
| Rise Time | t _r | $V_{DD} = 250 \text{ V}, \text{ I}_{D} = 16 \text{ A}$ | | - | 51 | - | | | |
| Turn-Off Delay Time | t _{d(off)} | $R_{G} = 7.5 \Omega, V_{GS} = 10 V$ see fig. 14a and 14b ^b | | - | 50 | - | - ns | | |
| Fall Time | t _f | | | - | 28 | - | | | |
| Drain-Source Body Diode Characteristic | s | L | | | | | | | |
| Continuous Source-Drain Diode Current | IS | MOSFET symbol showing the integral reverse p - n junction diode | | | - | - | 16 | | |
| Pulsed Diode Forward Current ^a | I _{SM} | | | - | - | 64 | A | | |
| Body Diode Voltage | V _{SD} | T _J = 25 °C | C, I _S = 16 A, V | $V_{\rm GS} = 0 \ \rm V^b$ | - | - | 1.5 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | T _J = 25 °C | | | - | 170 | 250 | | |
| | | T _J = 125 °C | | = 16 A, | - | 220 | 330 | ns | |
| Body Diode Reverse Recovery Charge | Q _{rr} | T _J = 25 °C | dl/dt = | 100 A/µs ^b | _ | 470 | 710 | | |
| | | T _J = 125 °C | | | - | 810 | 1210 | μC | |
| Reverse Recovery Current | I _{RRM} | 13 = 120 0 | Т _Ј = 25 °С | | - | 7.3 | 11 | <u> </u> | |
| Forward Turn-On Time | rRRM t _{on} | | | negligible (turn- | | | | <u> </u> | |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
b. Pulse width ≤ 300 µs; duty cycle ≤ 2 %.
c. C_{OSS} eff. is a fixed capacitance that gives the same charging time as C_{OSS} while V_{DS} is rising fom 0 % to 80 % V_{DS}. C_{OSS} eff. (ER) is a fixed capacitance that stores the same energy as C_{OSS} while V_{DS} is rising fom 0 % to 80 % V_{DS}.

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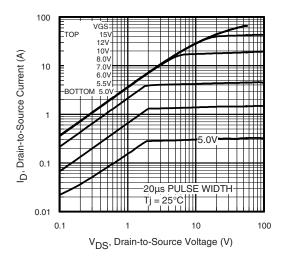


Fig. 1 - Typical Output Characteristics

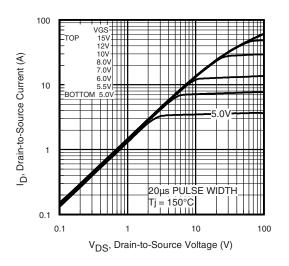


Fig. 2 - Typical Output Characteristics

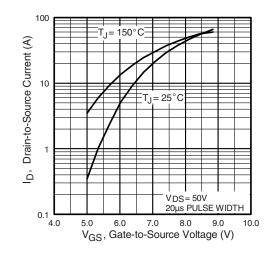


Fig. 3 - Typical Transfer Characteristics

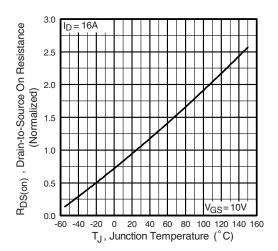


Fig. 4 - Normalized On-Resistance vs. Temperature

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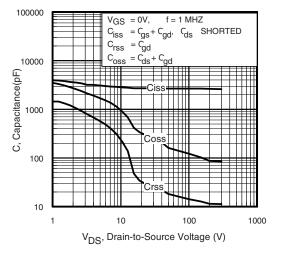


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

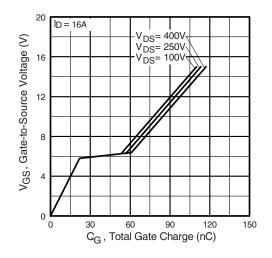


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

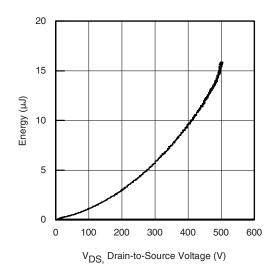


Fig. 6 - Typ. Output Capacitance Stored Energy vs. V_{DS}

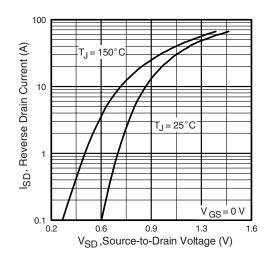


Fig. 8 - Typical Source-Drain Diode Forward Voltage



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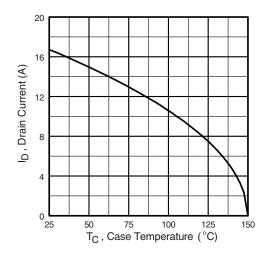


Fig. 9 - Maximum Drain Current vs. Case Temperature

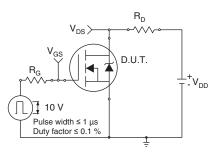


Fig. 10a - Switching Time Test Circuit

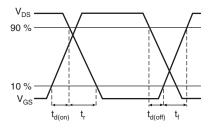


Fig. 10b - Switching Time Waveforms

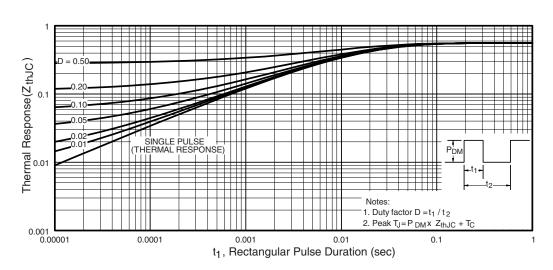


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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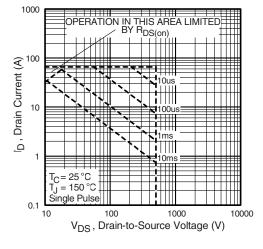


Fig. 12 - Maximum Safe Operating Area

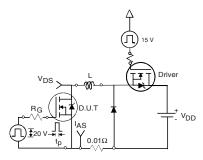


Fig. 14a - Unclamped Inductive Test Circuit

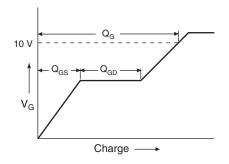


Fig. 15a - Basic Gate Charge Waveform

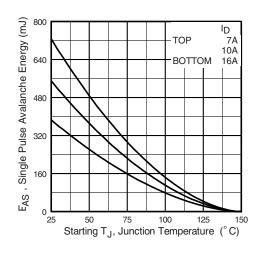


Fig. 13 - Maximum Avalanche Energy vs. Drain Current

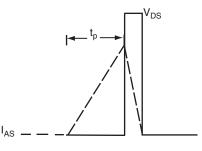
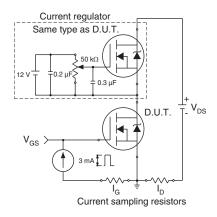


Fig. 14b - Unclamped Inductive Waveforms





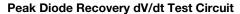
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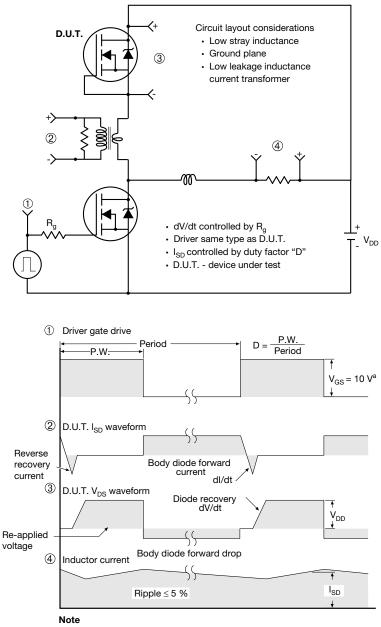
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a. V_{GS} = 5 V for logic level devices

Fig. 16. For N-Channel

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